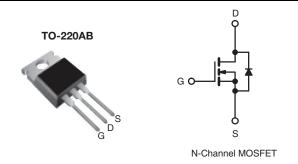


### Power MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 5.0 V 0.27			
Q <sub>g</sub> (Max.) (nC)	12			
Q <sub>gs</sub> (nC)	3.0			
Q <sub>gd</sub> (nC)	7.1			
Configuration	Single			



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C Operating Temperature
- Fast Switching
- · Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRL520PbF	
Leau (FD)-iree	SiHL520-E3	
SnPb	IRL520	
SIFD	SiHL520	

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	100	V	
Gate-Source Voltage		$V_{GS}$	± 10	V	
Continuous Drain Current	$V_{GS}$ at 5.0 V $T_C = 25 ^{\circ}C$	1	9.2		
	$V_{GS}$ at 5.0 $V_{C} = 100 ^{\circ}C$	ID	6.5	Α	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	36			
Linear Derating Factor			0.40	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	170	mJ	
Avalanche Current <sup>a</sup>		I <sub>AR</sub>	9.2	А	
Repetitive Avalanche Energya		E <sub>AR</sub>	6.0	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		60	W	
Peak Diode Recovery dV/dt <sup>c</sup>	dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature)	for 10 s	-	300 <sup>d</sup>		
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
Mounting Torque	0-32 OF IVIS SCIEW		1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 3.0 \, \text{mH}$ ,  $R_q = 25 \, \Omega$ ,  $I_{AS} = 9.2 \, \text{A}$  (see fig. 12).
- c.  $I_{SD} \le 9.2 \text{ A}$ ,  $dI/dt \le 110 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le V_{DS}$ ,  $T_{J} \le 175 \,^{\circ}\text{C}$ .
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greasd Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	2.5	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	2.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 10 V		-	-	± 100	nA	
Zoro Coto Voltago Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	-	25		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 80 \text{ V}$	V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA	
Drain-Source On-State Resistance	D	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 5.5 A <sup>b</sup>	-	-	0.27		
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.0 V	I <sub>D</sub> = 4.6 A <sup>b</sup>	-	-	0.38	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	= 50 V, I <sub>D</sub> = 5.5 A	3.2	-	-	S	
Dynamic								
Input Capacitance	$C_{iss}$		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		490	-	pF	
Output Capacitance	Coss				150	-		
Reverse Transfer Capacitance	$C_{rss}$	t = 1.	0 MHz, see fig. 5	-	30	-		
Total Gate Charge	$Q_g$			-	-	12		
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 5.0 \text{ V}$	$I_D = 9.2 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	3.0	nC	
Gate-Drain Charge	$Q_{gd}$			-	-	7.1		
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.8	-		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 50 V, I <sub>D</sub> = 9.2 A,	-	64	-	ne	
Turn-Off Delay Time	$t_{d(off)}$	$R_g = 9.0 \Omega$ , $R_D = 5.2 \Omega$ , see fig. $10^b$		-	21	-	ns	
Fall Time	t <sub>f</sub>			-	27	-		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact  - 4.5		-	nH			
Internal Source Inductance	L <sub>S</sub>			-	7.5	1	ווח	
<b>Drain-Source Body Diode Characteristic</b>	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol showing the		-	9.2	A	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction	¬	-	_	36		
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 9.2 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T 25 °C 1	= 9.2 A, dl/dt = 100 A/µsb	-	130	190	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	] IJ = 25 <sup>-</sup> U, I <sub>F</sub>	= 9.∠ A, αi/αι = 100 A/μS <sup>0</sup>	-	0.83	1.0	μC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

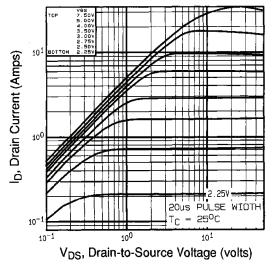


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

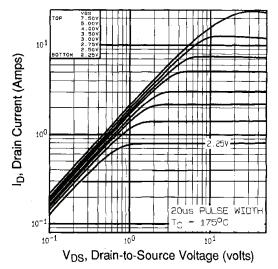


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

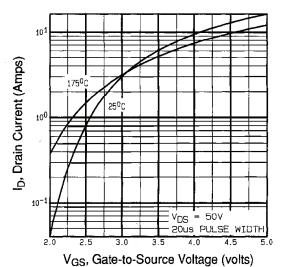


Fig. 3 - Typical Transfer Characteristics

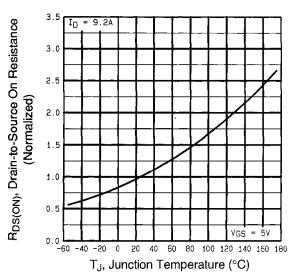


Fig. 4 - Normalized On-Resistance vs. Temperature



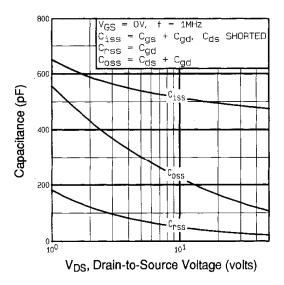


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

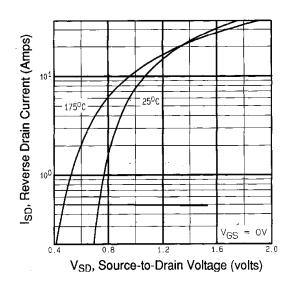


Fig. 7 - Typical Source-Drain Diode Forward Voltage

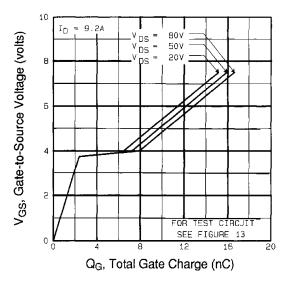


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

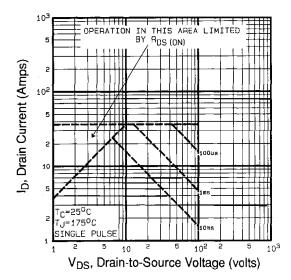


Fig. 8 - Maximum Safe Operating Area





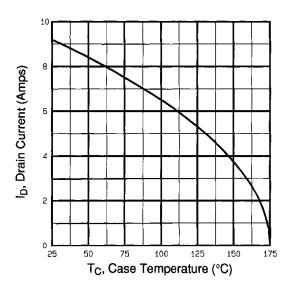


Fig. 9 - Maximum Safe Operating Area

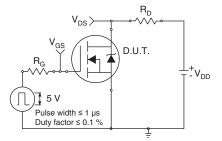


Fig. 10a - Switching Time Test Circuit

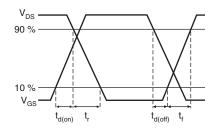


Fig. 10b - Switching Time Waveforms

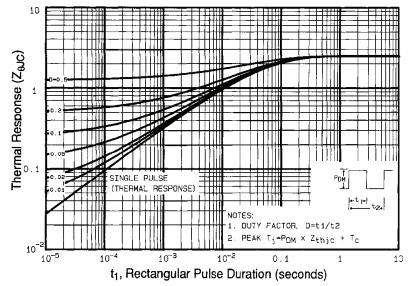
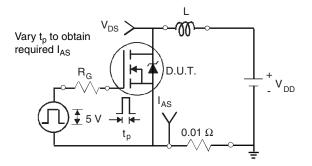


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





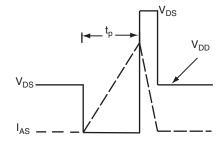


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

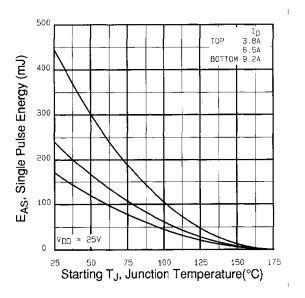


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

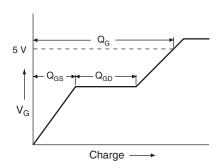


Fig. 13a - Basic Gate Charge Waveform

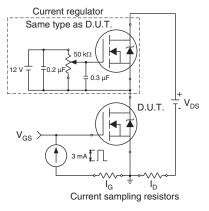
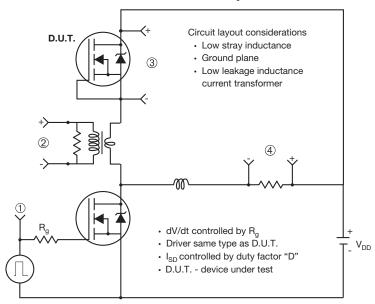


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



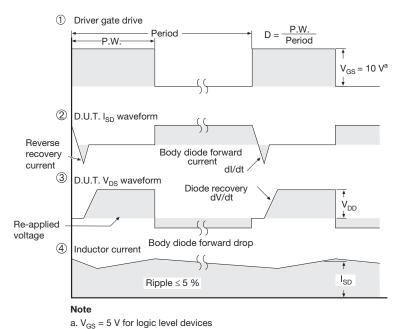


Fig. 14 - For N-Channel

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# TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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